			·				Page 1 of	
Subst. Form PTO-1449 APPLICANT'S INFORMATION DISCLOSURE STATEMENT			Atty. Docket No.: END920030018US1 (IEN-10-5765)			Serial No.: To be assigned		
			Applicant: Biggs et al				10/066 775	
			Filing Date: Herewith 9 18 03			Group: 2813		
		<u> </u>	<u> </u>	S. PATENT DOCUMENTS	-		0013	
	-	·	· · · · · · · · · · · · · · · · · · ·	S. PATENT DOCUMENTS				
Initial*		Document No.	Date	Name	Class	Subcl.	Filing Date	
TSP	_AA	5,885,891	03/23/99	Miyata et al	438	612	07/16/97	
759	AB	6,077,766	06/20/00	Sebesta et al	438	618	06/25/99	
TSP	AC	6,376,371 B1	04/23/02	Jain et al	438	681	05/12/00	
ISP	AD	6,387,793 B1	05/14/02	Yap et al	438	612	03/09/00	
	AE							
	AF						,	
	AG							
	AH							
	AI							
	AJ							
	AK						,	
			FORE	IGN PATENT DOCUMENT	'S	<u> </u>		
		Document No.	Date	Country	Class	Subcl.	Translation?	
	AL	-						
	AM							
	NA							
				OTHER DOCUMENTS				
SP	AO	IBM Technical Disclosure Bulletin, "Electroless Gold Plating of Thick Films", M. M. Haddad, Vol. 16, No. 4, September, 1973						
	AP		· · · · · · · · · · · · · · · · · · ·					
	AQ							
	AR		***************************************	"				
	AS							
	AT							
Examiner:		601		Date Considered:	10/19/04			

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformation with MPEP 609; draw line through citation if in conformance and not considered. Include copy of this form with next communication to applicant.